

FDP025N06 N-Channel PowerTrench[®] MOSFET 60 V, 265 A, 2.5 mΩ

Features

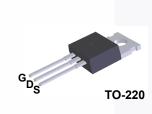
- $R_{DS(on)}$ = 1.9 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 75 A
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

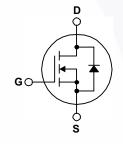
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies
- Renewable system





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

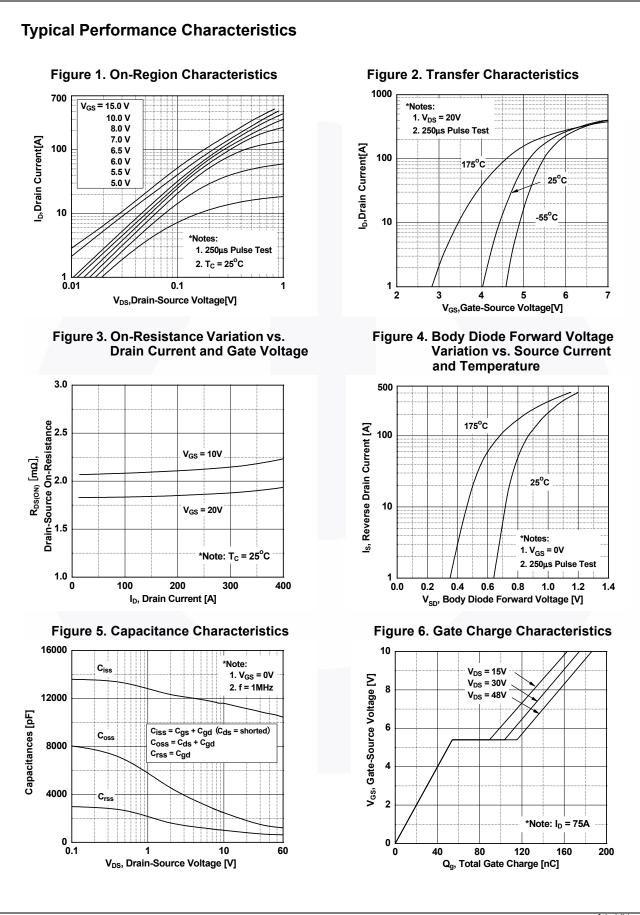
Symbol		Parameter	FDP025N06	Unit	
V _{DSS}	Drain to Source Voltage	60	V		
V _{GSS}	Gate to Source Voltage		±20	V	
ID		- Continuous (T _C = 25°C, Silicon Limited)	265		
	Drain Current	- Continuous (T _C = 100°C, Silicon Limited	l) 190	Α	
		- Continuous (T _C = 25°C, Package Limite	d) 120		
I _{DM}	Drain Current	- Pulsed (Note	1) 1060	А	
E _{AS}	Single Pulsed Avalanche Er	2) 2531	mJ		
dv/dt	Peak Diode Recovery dv/dt	3) 6.0	V/ns		
P _D	Dower Dissinction	(T _C = 25°C)	395	W	
	Power Dissipation	- Derate Above 25°C	2.6	W/ºC	
T _J , T _{STG}	Operating and Storage Tem	-55 to +175	°C		
TL	Maximum Lead Temperature	e for Soldering, 1/8" from Case for 5 Seconds	300	°C	

Thermal Characteristics

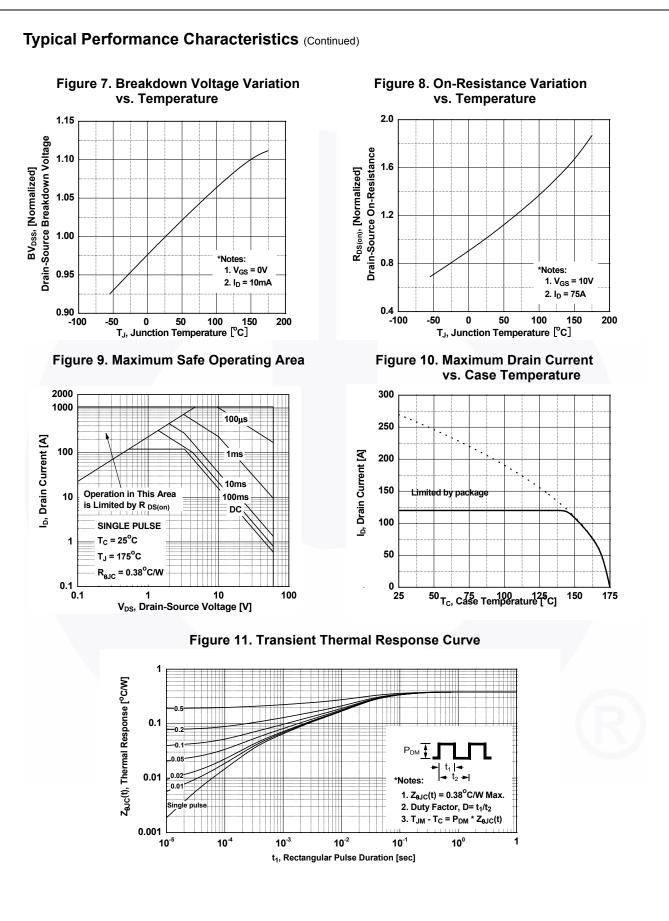
Symbol	Parameter	FDP025N06	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.38	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	0/11

November 2013

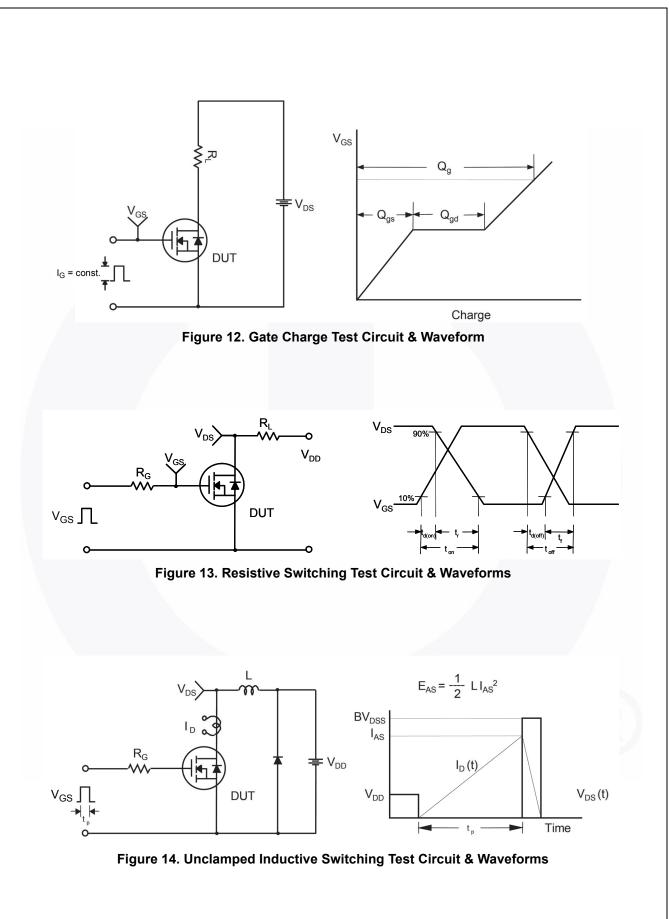
		Packa	ige	Packing Method	Reel Size) T	ape Width	Qua	antity	
		TO-2			N/A	N/A		50 units		
Electrica	l Char	acteristics T _C = 2	25°C unles	s othe	erwise noted.					
Symbol		Parameter			Test Condition	S	Min.	Тур.	Max.	Unit
Off Chara	cteristic	S								
BV _{DSS}	Drain to Source Breakdown Voltage		tage	I _D = 250 μA, V _{GS} = 0 V			60	-	-	V
∆BV _{DSS}		Breakdown Voltage Temperature		$I_D = 250 \ \mu$ A, Referenced to 25° C				0.04		N/00
$/\Delta T_J$	Coefficient						-	0.04	-	V/°C
	Zero G	ate Voltage Drain Currer	ht.	V_{DS}	= 60 V, V _{GS} = 0 V		-	-	1	μA
I _{DSS} Zero Gate Voltage Drain Current				= 60 V, V _{GS} = 0 V, T	_C = 150 ^o C	-	-	500	μΛ	
GSS	Gate to	Body Leakage Current		V_{GS}	= ±20 V, V _{DS} = 0 V		-	-	±100	nA
On Chara	teristic	e								
V _{GS(th)}		nreshold Voltage	-	Voo	= V _{DS} , I _D = 250 μA		2.5	3.5	4.5	V
R _{DS(on)}		rain to Source On Resis	stance		$= 10 \text{ V}, \text{ I}_{\text{D}} = 75 \text{ A}$		-	1.9	2.5	mΩ
9 _{FS}		d Transconductance			= 10 V, I _D = 75 A		-	200	-	S
				1.02						_
Dynamic (1						1
C _{iss}		apacitance		V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		-	-	11190	14885	pF
C _{oss}		Capacitance	_			_	-	1610	2140	pF
C _{rss}		e Transfer Capacitance					-	750	1125	pF
Q _{g(tot)}		ate Charge at 10V			= 48 V, I _D = 75 A	-	-	174	226	nC
Q _{gs}		Source Gate Charge		V _{GS} = 10 V		(Note 4)	-	54	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge				(Note 4)	-	50	-	nC
Switching	Charac	teristics								
t _{d(on)}	Turn-Or	n Delay Time				-	134	278	ns	
r	Turn-On Rise Time			V _{DD} = 30 V, I _D = 75 A,			-	324	658	ns
t _{d(off)}	Turn-Of	f Delay Time		V_{GS} = 10 V, R_G = 25 Ω (Note 4)		-	348	706	ns	
t _f	Turn-Of	f Fall Time				•	250	510	ns	
Jrain-Sou	rce Dio	de Characteristics								
	1	m Continuous Drain to S		de Fr	rward Current			-	265	А
I _S I _{SM}	Maximum Pulsed Drain to Source Diode					-	-	1060	A	
V _{SD}	Drain to Source Diode Forward Voltage			$V_{GS} = 0 V, I_{SD} = 75 A$		-	-	1.3	V	
rr SD		Recovery Time	vollago	$V_{GS} = 0 V, I_{SD} = 75 A,$			-	69	-	ns
Q _{rr}	Reverse Recovery Charge			$v_{GS} = 0 v, i_{SD} = 75 A,$ $dI_{F}/dt = 100 A/\mu s$		-	152		nC	



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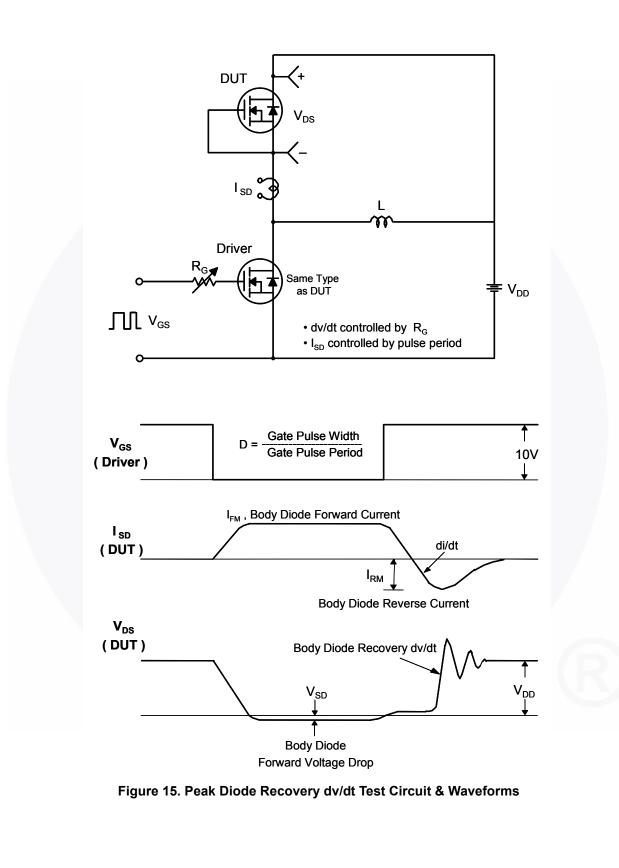


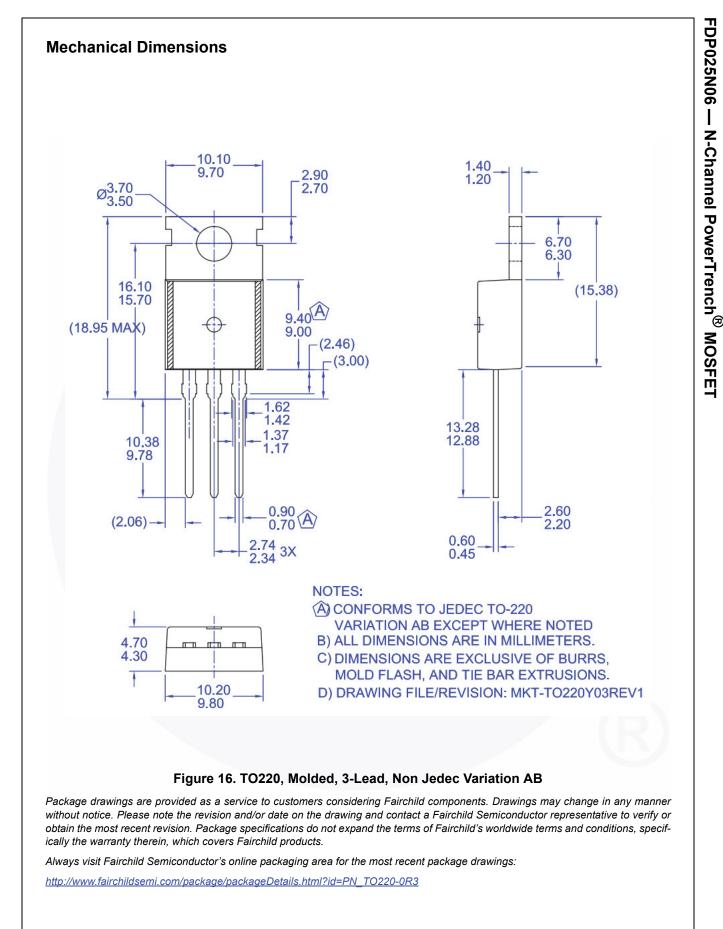
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